# VSMB1940X01



**Vishay Semiconductors** 

# High Speed Infrared Emitting Diode, 940 nm, GaAIAs Double Hetero



VSMB1940X01 is an infrared, 940 nm emitting diode in

GaAlAs Double Hetero technology with high radiant power and high speed, molded in clear, untinted 0805 plastic • Package type: surface mount

- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- Peak wavelength:  $\lambda_p = 940 \text{ nm}$
- High reliability
- High radiant power
- High radiant intensity
- High speed
- Angle of half sensitivity:  $\varphi = \pm 60^{\circ}$
- Low forward voltage
- Suitable for high pulse current operation
- 0805 standard surface-mountable package
- Floor life: 168 h, MSL 3, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <a href="http://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### APPLICATIONS

- High speed IR data transmission
- · High power emitter for low space applications
- High performance transmissive or reflective sensors

# PRODUCT SUMMARY COMPONENT Ie (mW/sr) φ (deg) λp (nm) tr (ns) VSMB1940X01 6 ± 60 940 15

Note

DESCRIPTION

• Test conditions see table "Basic Characteristics"

package for surface mounting (SMD).

ORDERING INFORMATION							
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM				
VSMB1940X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805				

#### Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage		V <sub>R</sub>	5	V			
Forward current		I <sub>F</sub>	100	mA			
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I <sub>FM</sub>	200	mA			
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	1	A			
Power dissipation		Pv	160	mW			
Junction temperature		Тj	100	°C			
Operating temperature range		T <sub>amb</sub>	-40 to +85	°C			
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C			
Soldering temperature	According to Fig. 9, J-STD-020	T <sub>sd</sub>	260	°C			
Thermal resistance junction / ambient	JESD 51	R <sub>thJA</sub>	270	K/W			

1 or technical questions. contact: emittertechsupport@vishav.co Document Number: 81933



RoHS

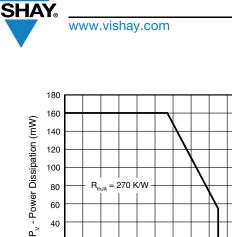
COMPLIANT HALOGEN

FREE

**GREEN** 

(5-2008)





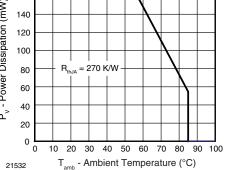


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

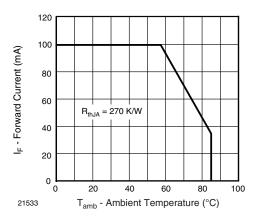


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	V <sub>F</sub>	1.15	1.35	1.6	V
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	V <sub>F</sub>	-	2.2	-	V
Temperature coefficient of $V_{\rm F}$	I <sub>F</sub> = 1 mA	TK <sub>VF</sub>	-	-1.5	-	mV/K
	I <sub>F</sub> = 100 mA	TK <sub>VF</sub>	-	-1.1	-	mV/K
Reverse current	$V_R = 5 V$	I <sub>R</sub>	-	-	10	μA
Junction capacitance	$V_R = 0 V$ , f = 1 MHz, E = 0 mW/cm <sup>2</sup>	CJ	-	70	-	pF
Radiant intensity	I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms	l <sub>e</sub>	3	6	12	mW/sr
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	l <sub>e</sub>	-	60	-	mW/sr
Radiant power	$I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	фе	-	40	-	mW
Temperature coefficient of radiant power	I <sub>F</sub> = 1 mA	TKφ <sub>e</sub>	-	-1.1	-	%/K
	I <sub>F</sub> = 100 mA	TKφ <sub>e</sub>	-	-0.51	-	%/K
Angle of half intensity		φ	-	± 60	-	deg
Peak wavelength	I <sub>F</sub> = 30 mA	λρ	-	940	-	nm
Spectral bandwidth	I <sub>F</sub> = 30 mA	Δλ	-	25	-	nm
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 30 mA	TK <sub>λp</sub>	-	0.25	-	nm
Rise time	$I_F$ = 100 mA, 20 % to 80 %	t <sub>r</sub>	-	15	-	ns
Fall time	$I_F$ = 100 mA, 20 % to 80 %	t <sub>f</sub>	-	15	-	ns
Virtual source diameter		d	-	0.5	-	mm





### BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

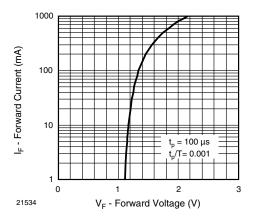


Fig. 3 - Forward Current vs. Forward Voltage

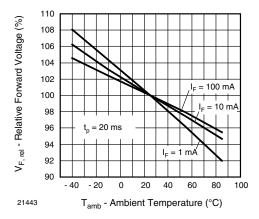


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

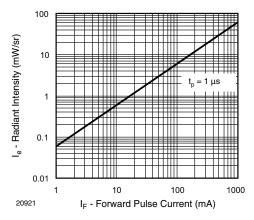


Fig. 5 - Radiant Intensity vs. Forward Current

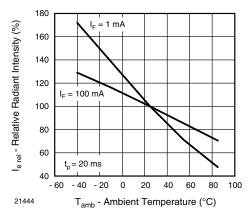


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

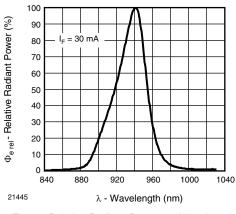


Fig. 7 - Relative Radiant Power vs. Wavelength

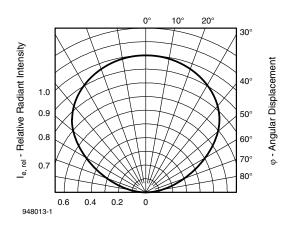


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

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### **REFLOW SOLDER PROFILE**

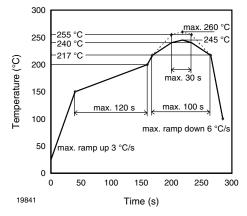


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

### **PACKAGE DIMENSIONS** in millimeters

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

### FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

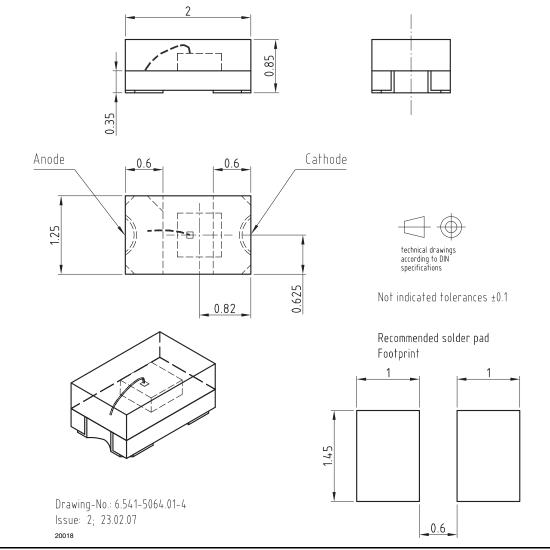
Moisture sensitivity: level 3

Floor life: 168 h

Conditions:  $T_{amb} < 30$  °C, RH < 60 %

### DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



Rev. 1.5, 30-Jun-16

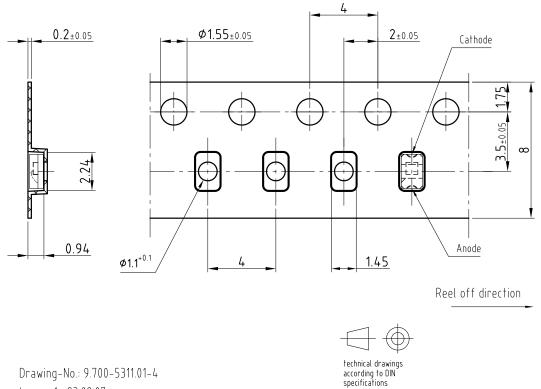
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### **BLISTER TAPE DIMENSIONS** in millimeters



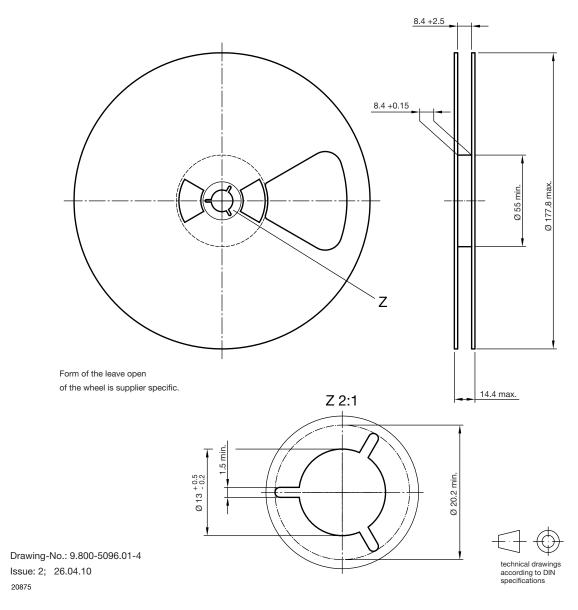
Drawing-No.: 9.700-5311.01-4 Issue: 1; 23.02.07 21501

Not indicated tolerances ±0.1





### **REEL DIMENSIONS** in millimeters



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